

# **Data Sheet**

# HDSP-701x, HDSP-703x, HDSP-711x, and HDSP-713x Series

# 17.3-mm (0.68-inch) General-Purpose 5x7 Dot Matrix Alphanumeric Displays



#### Description

The Broadcom<sup>®</sup> HDSP-701x, HDSP-703x, HDSP-711x, and HDSP-713x Series displays have a 17.3-mm (0.68-inch) character height and use an industry-standard size and pinout. The devices are available in either common row anode or common row cathode configurations. The displays come in either gray or black face paint and are available in a choice of red, green, or deep red.

## Applications

- Suitable for indoor use
- Not recommended for industrial application
- Extreme temperature cycling not recommended

#### **Features**

- 5 × 7 dot matrix font
- Viewable up to 12 meters
- X-Y stackable
- Industry-standard pinout:
  - 7.6-mm (0.3 in.) dual-in-line (DIP) leads on
    2.54-mm (0.1 in.) centers
- Choice of colors:
- Red, green, and deep red
- Choice of face paint colors:
  - Gray or black
- Design flexibility:
  - Common row anode or common row cathode
- Categorized for luminous intensity
- Green categorized for color

| Red       | Green     | Deep Red  | Description                              |  |
|-----------|-----------|-----------|--|--|
| HDSP-701E | HDSP-701G | HDSP-701A | 17.3-mm Gray-Surface Common Row Anode    |  |
| HDSP-703E | HDSP-703G | HDSP-703A | 17.3-mm Gray-Surface Common Row Cathode  |  |
| HDSP-711E | HDSP-711G | HDSP-711A | 17.3-mm Black-Surface Common Row Anode   |  |
| HDSP-713E | HDSP-713G | HDSP-713A | 17.3-mm Black-Surface Common Row Cathode |  |

#### **Ordering Information**



## **Package Dimensions**

#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. Unless otherwise stated, the tolerance is  $\pm 0.25$  mm (0.010 in.).
- 3. For green only.

## **Internal Circuit Diagram**

#### Figure 1: Common Anode and Cathode Rows



x = ROW OR COLUMN NUMBER, (x) = PIN NUMBER

| CON | COMMON ROW ANODE                           |     | COMMON ROW CATHODE                         |  |  |
|-----|--|-----|--|--|--|
| PIN | HDSP-701E/711E/<br>701G/711G/<br>701A/711A | PIN | HDSP-703E/713E/<br>703G/713G/<br>703A/713A |  |  |
| 1   | COLUMN 1 CATHODE                           | 1   | ROW 1 CATHODE                              |  |  |
| 2   | ROW 3 ANODE                                | 2   | ROW 2 CATHODE                              |  |  |
| 3   | COLUMN 2 CATHODE                           | 3   | COLUMN 2 ANODE                             |  |  |
| 4   | ROW 5 ANODE                                | 4   | COLUMN 1 ANODE                             |  |  |
| 5   | ROW 6 ANODE                                | 5   | ROW 6 CATHODE                              |  |  |
| 6   | ROW 7 ANODE                                | 6   | ROW 7 CATHODE                              |  |  |
| 7   | COLUMN 4 CATHODE                           | 7   | COLUMN 3 ANODE                             |  |  |
| 8   | COLUMN 5 CATHODE                           | 8   | ROW 5 CATHODE                              |  |  |
| 9   | ROW 4 ANODE                                | 9   | COLUMN 4 ANODE                             |  |  |
| 10  | COLUMN 3 CATHODE                           | 10  | ROW 4 CATHODE                              |  |  |
| 11  | ROW 2 ANODE                                | 11  | ROW 3 CATHODE                              |  |  |
| 12  | ROW 1 ANODE                                | 12  | COLUMN 5 ANODE                             |  |  |

# Absolute Maximum Ratings at T<sub>A</sub> = 25°C

| Description  | Red<br>HDSP-701E/703E/<br>711E/713E | Deep Red<br>HDSP-701A/703A/<br>711A/713A | Green<br>HDSP-701G/703G/<br>711G/713G | Unit |
|--|-------------------------------------|--|---------------------------------------|------|
| Power Dissipation per Dot  | 62.5                                | 52                                       | 62.5                                  | mW   |
| Peak Forward Current per Dot <sup>a</sup>  | 90                                  | 60                                       | 90                                    | mA   |
| DC Forward Current per Dot   | 25 <sup>b</sup>                     | 20 <sup>c</sup>                          | 25 <sup>d</sup>                       | mA   |
| Reverse Voltage per Dot <sup>e</sup>   |                                     | 5  |                                       | V    |
| Operating Temperature  | -40 to +85                          | -40 to +85                               | -40 to +85                            | °C   |
| Storage Temperature  | -40 to +85                          | -40 to +85                               | -40 to +85                            | °C   |
| Wave Soldering Temperature for 3 Seconds <sup>f</sup><br>(1.6-mm [0.063 in.] below body) | 250                                 | 250                                      | 250                                   | °C   |

a. Duty factor = 10%, frequency = 1 kHz,  $T_A = 25^{\circ}C$ .

b. Derate linearly as shown in Figure 5.

c. Derate linearly as shown in Figure 9.

d. Derate linearly as shown in Figure 13.

e. Reverse voltage is for LED testing purposes and is not recommended to be used as an application condition.

f. Not recommended to be soldered more than two times. Minimum interval between solderings is 15 minutes. Total soldering time not to exceed 5 seconds.

# **Optical/Electrical Characteristics at T<sub>A</sub> = 25°C**

| Parameter  | Symbol           | Min. | Тур. | Max. | Unit | Test Conditions         |
|--|------------------|------|------|------|------|-------------------------|
| Red Devices: HDSP-701E/703E/711E/713E                        |                  |      | 1    |      |      |                         |
| Luminous Intensity/Dot <sup>a,b,c</sup><br>(Digital Average) | ۱ <sub>V</sub>   | 2.90 | 6.80 | —    | mcd  | I <sub>F</sub> = 10 mA  |
| Peak Wavelength  | λ <sub>P</sub>   | _    | 633  | _    | nm   | I <sub>F</sub> = 20 mA  |
| Dominant Wavelength <sup>d</sup>                             | λ <sub>d</sub>   |      | 622  |      | nm   | I <sub>F</sub> = 20 mA  |
| Forward Voltage <sup>e</sup>                                 | V <sub>F</sub>   |      | 1.95 | 2.50 | V    | I <sub>F</sub> = 20 mA  |
| Reverse Voltage <sup>f</sup>                                 | V <sub>R</sub>   | 5    |      |      | V    | I <sub>R</sub> = 100 mA |
| Luminous Intensity Matching Ratio                            | I <sub>V-M</sub> |      | —    | 2:1  |      | I <sub>F</sub> = 10 mA  |
| Green Devices: HDSP-701G/703G/711G/7                         | 13G              |      |      |      |      |                         |
| Luminous Intensity/Dot <sup>a,b,c</sup><br>(Digital Average) | ۱ <sub>V</sub>   | 0.96 | 4.20 | _    | mcd  | I <sub>F</sub> = 10 mA  |
| Peak Wavelength  | λ <sub>P</sub>   | —    | 572  |      | nm   | I <sub>F</sub> = 20 mA  |
| Dominant Wavelength <sup>d</sup>                             | λ <sub>d</sub>   |      | 570  |      | nm   | I <sub>F</sub> = 20 mA  |
| Forward Voltage <sup>e</sup>                                 | V <sub>F</sub>   | 1.80 | 2.10 | 2.50 | V    | I <sub>F</sub> = 20 mA  |
| Reverse Voltage <sup>f</sup>                                 | V <sub>R</sub>   | 5    | —    |      | V    | I <sub>R</sub> = 100 mA |
| Luminous Intensity Matching Ratio                            | I <sub>V-M</sub> |      | —    | 2:1  |      | I <sub>F</sub> = 10 mA  |
| Deep Red Devices: HDSP-701A/703A/711                         | A/713A           |      |      |      |      |                         |
| Luminous Intensity/Dot <sup>a,b,c</sup><br>(Digital Average) | ۱ <sub>V</sub>   | 1.55 | 2.10 | —    | mcd  | I <sub>F</sub> = 2 mA   |
| Peak Wavelength  | λ <sub>P</sub>   | —    | 660  | _    | nm   | I <sub>F</sub> = 20 mA  |
| Dominant Wavelength <sup>d</sup>                             | λ <sub>d</sub>   |      | 640  |      | nm   | I <sub>F</sub> = 20 mA  |
| Forward Voltage <sup>e</sup>                                 | V <sub>F</sub>   |      | 2.00 | 2.60 | V    | I <sub>F</sub> = 20 mA  |
| Reverse Voltage <sup>f</sup>                                 | V <sub>R</sub>   | 5    | _    | _    | V    | I <sub>R</sub> = 100 mA |
| Luminous Intensity Matching Ratio                            | I <sub>V-M</sub> | —    | —    | 2:1  |      | I <sub>F</sub> = 2 mA   |

a. The luminous intensity,  ${\sf I}_{\sf V},$  is measured at the mechanical axis of the package.

b. The optical axis is closely aligned with the mechanical axis of the package.

c. Tolerance is ±15%.

d. The dominant wavelength,  $\lambda_d$ , is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.

e. Forward voltage tolerance is ±0.1V.

f. Reverse voltage is for product testing only. Long-term reverse bias is not recommended for end applications.

#### Red





Figure 4: Relative Luminous Intensity vs. Forward Current



90 80 FORWARD CURRENT - mA 70 60 50 40 30 20 10 0 0.5 1.0 1.5 2.0 2.5 FORWARD VOLTAGE - V

Figure 3: Forward Current vs. Forward Voltage

Figure 5: Maximum Forward Current vs. Ambient Temperature



# **Deep Red**

Figure 6: Relative Intensity vs.Wavelength



Figure 8: Relative Luminous Intensity vs. Forward Current





Figure 7: Forward Current vs. Forward Voltage

Figure 9: Maximum Forward Current vs. Ambient Temperature



#### Green

Figure 10: Relative Intensity vs. Wavelength



Figure 12: Relative Luminous Intensity vs. Forward Current



90 80 FORWARD CURRENT - mA 70 60 50 40 30 20 10 0 0.5 1.0 1.5 2.0 2.5 FORWARD VOLTAGE - V

Figure 11: Forward Current vs. Forward Voltage

Figure 13: Maximum Forward Current vs. Ambient Temperature



# **Intensity Bin Limits**

# Red (mcd at 10 mA)

| IV Bin Category | Min.  | Max.   |
|-----------------|-------|--------|
| G               | 2.900 | 4.350  |
| Н               | 4.350 | 6.525  |
| I               | 6.525 | 9.785  |
| K               | 9.785 | 14.675 |

Tolerance for each bin limit is  $\pm 15\%$ .

#### Green (mcd at 10 mA)

| IV Bin Category | Min.  | Max.  |
|-----------------|-------|-------|
| Н               | 0.961 | 1.440 |
| I               | 1.441 | 2.150 |
| J               | 2.150 | 3.230 |
| К               | 3.231 | 4.850 |
| L               | 4.850 | 7.280 |

Tolerance for each bin limit is  $\pm 15\%$ .

#### Deep Red (mcd at 2 mA)

| IV Bin Category | Min.  | Max.  |
|-----------------|-------|-------|
| I               | 1.550 | 2.330 |
| J               | 2.330 | 3.490 |

Tolerance for each bin limit is  $\pm 15\%$ .

# Color Bin Limits<sup>1</sup> (Dominant Wavelength)

|       |     | Dominant Wavelength (nm) |       |  |
|-------|-----|--------------------------|-------|--|
| Color | Bin | Min.                     | Max.  |  |
| Green | 2   | 573.6                    | 576.5 |  |
|       | 3   | 570.6                    | 573.5 |  |
|       | 4   | 567.6                    | 570.5 |  |
|       | 5   | 564.5                    | 567.5 |  |

<sup>1.</sup> Bin categories are established for classification of products. Products might not be available in all bin categories.

# **Precautionary Notes**

# **Soldering and Handling Precautions**

- Set and maintain the wave soldering parameters according to the recommended temperature and dwell time. Perform daily checks on the profile to ensure that it is always conforming to the recommended conditions. Exceeding these conditions will overstress the LEDs and cause premature failures.
- Use only bottom preheaters to reduce thermal stress experienced by the LEDs.
- Recalibrate the soldering profile before loading a new type of PCB. PCBs with different sizes and designs (component density) will have different heat capacities and might cause a change in temperature experienced by the PCB if the same wave soldering setting is used.
- Do not perform wave soldering more than once.
- Any alignment fixture used during wave soldering must be loosely fitted and must not apply stress on the LEDs. Use nonmetal material because it will absorb less heat during the wave soldering process.
- At elevated temperatures, the LEDs are more susceptible to mechanical stress. Allow the PCB to sufficiently cool to room temperature before handling. Do not apply stress to the LED when it is hot.
- Use wave soldering to solder the LED. Use hand soldering only for rework or touch-up if unavoidable, but it must be strictly controlled to following conditions:
  - Soldering iron tip temperature = 315°C maximum
  - Soldering duration = 2 seconds maximum
  - Number of cycles = 1 only
  - Power of soldering iron = 50W maximum
- For ESD-sensitive devices, apply proper ESD precautions at the soldering station. Use only an ESD-safe soldering iron.
- Do not touch the LED package body with the soldering iron except for the soldering terminals because it may cause damage to the LED.
- Confirm beforehand whether the functionality and performance of the LED are affected by soldering with hand soldering.
- Keep the heat source at least 1.6 mm away from the LED body during soldering.
- Design an appropriate hole size to avoid problems during insertion.
- Cleaning agents from the ketone family (acetone, methyl ethylketone, and so on) and from the chlorinated hydrocarbon family (methylene chloride, trichloroethylene, carbon tetrachloride, and so on) are

not recommended for cleaning the LED displays. All of these various solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

- For the purpose of cleaning, wash with DI water only. The cleaning process should take place at room temperature only. Clear any water or moisture from the LED display immediately after washing.
- Use of *No clean* solder paste is recommended for soldering.

#### Figure 14: Recommended Wave Soldering Profile



**NOTE:** Figure 14 refers to measurements with a thermocouple mounted at the bottom of the PCB.

#### **Application Precautions**

- The drive current of the LED must not exceed the maximum allowable limit across temperatures as stated in this data sheet. Constant current driving is recommended to ensure consistent performance.
- Circuit design must cater to the whole range of forward voltage (V<sub>F</sub>) of the LEDs to ensure that the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation in performance (such as intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.

- Avoid rapid changes in ambient temperatures, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in a harsh or outdoor environment, protect the LED against damages caused by rain, water, dust, oil, corrosive gases, external mechanical stresses, and so on.

#### **Eye Safety Precautions**

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment.

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